

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Lee

For: Light Guide Panel Using Stamper, and Method and Device for
Producing the Same

Serial No.: 10/595,369

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Examiner: Wong

Group Art Unit: 2874

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Commissioner for Patents
P.O. Box 1450
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Sir:

INFORMATION DISCLOSURE STATEMENT

Applicant wishes to call to the attention of the Examiner
the following prior art. Copies of the references are enclosed as
is a completed form PTO/SB/08a.

Korean Patent Publication No. 1020030032575

Korean Patent Publication No. 1020000046665

U.S. Patent Application Publication No. 20020145861

WIPO Patent Publication No. WO0057241

WIPO Patent Publication No. WO9854606

Japanese Patent Publication No. 9222514

The present invention is patentably distinct from the
disclosures of the above cited references in that the structures

disclosed in the cited references are not characterized by a substrate for the light guide panel 30 having an inner perimeter of 15mm, an outer perimeter of 120 to 300mm, and a thickness of 0.4 to 1.5mm, and a dimensional error of an inner perimeter, an outer perimeter, and a thickness of the substrate and the laser stamper is within a range of $\pm 10\%$.

Moreover, the structures disclosed in the cited references are not characterized by the laser stamper producing part(A) having a substrate cleaning and drying unit(50), a photosensitizer coating/heating/cooling unit(51), a laser beam recording unit(52), a developing unit(53), a seed layer coating unit(54), a metal master producing unit(55), a rear surface processing unit(56), and a stamper cutting unit(57).

Also, the structures disclosed in the cited references are not characterized by the light guide(B) having an injection molding unit(58) and a light guide panel cutting unit(59).

From the foregoing it is seen that none of the cited references affects the claims in the instant application.

Respectfully Submitted,

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HFM:cnt
enc.